

**PLEDxUSWxA Series - Unidirectional, White Body**



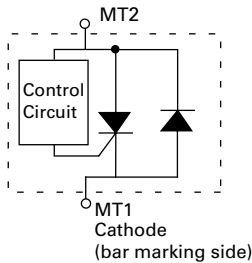
**OBSOLETE** DATE: 03/26/2020 PCN/ECN# 41325  
REPLACED BY: PLEDxUSxA series



**Agency Approvals**

Agency	Agency File Number
	E133083

**Schematic Symbol**



**Description**

PLEDxUSWxA open LED protectors provide a switching electronic shunt path when an LED in an electronic switching fails as an open circuit. This ensures that the remaining string of LEDs will continue to function if a single LED does not.

The device is designed to enable higher reliability in indoor LED lighting applications such as advertisement lighting and other applications. Additionally, it is molded from white material to make them less visible in the LED fixture and the white molding also reflects more light to improve overall light engine efficiency.

This series is compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic and is available in an SMB, PLEDxUSWxA is available in SMB surface mount package. The DO-214AA (SMB) low profile package is ideal for dense board applications.

**Features & Benefits**


- Ideal for protecting high brightness LED with high operating current at specified condition.
- White compound for better optical appearances
- Fast switching
- Reverse Battery/Power Protection
- Low profile, small foot print standard DO-214AA package
- Compatible with industrial lighting environments
- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- Compatible with PWM frequencies up to 30 kHz
- RoHS compliant and halogen-free
- Pb-free E3 means 2<sup>nd</sup> level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

**Electrical Characteristics** (All parameters are measured at T=25°C unless otherwise noted)

Part Number	Marking	$V_{BR}$ breakdown		$V_{DRM}$ breakdown	$I_H$	$I_S$	$I_T @ V_T$	$V_T @ I_T = 1$ Amp	$I_o^1$	Critical rate of rise dV/dt
		Volts		Volts	mAmps	mAmps	Amps	Volts	Amps	
		Min	Max	Min	Min	Max	Max	Max	Max	
PLED6USW2A	PL62A	6	16	6	5	100	1.0	1.2	2	250V/μs
PLED6USW3A	PL63A	6	16	6	5	100	1.0	1.2	3	250V/μs
PLED9USW3A	PL93A	9	18	9	5	100	1.0	1.2	3	250V/μs

Notes:  
1.  $I_o$  - Operation current tested @ aluminum boards, ambient temp 85C

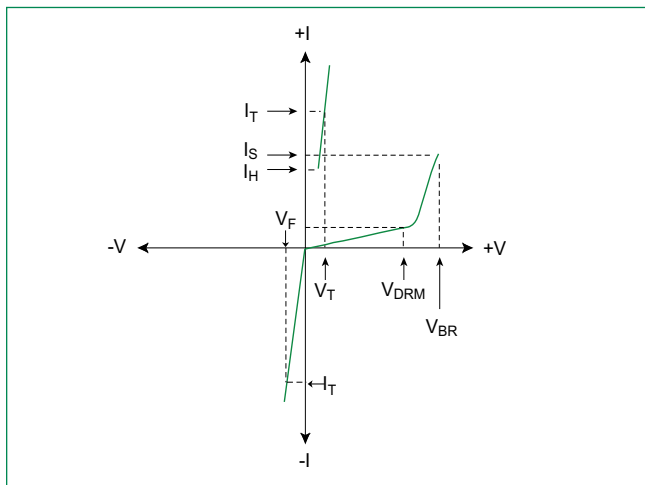
**Thermal Considerations**

Package	Symbol	Parameter	Value	Unit
DO-214AA in White 	$T_J$	Operating Junction Temperature Range	-40 to +150	°C
	$T_S$	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	DO-214AA: 90 <sup>1</sup> DO-214AA: 40 <sup>2</sup>	°C/W

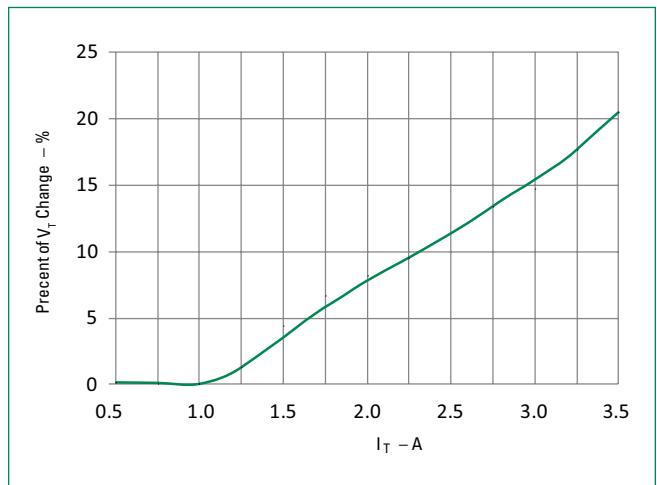
Notes:

- 1) Standard FR-4 PCB with Copper Pads (Recommended Size)
- 2) Aluminum PCB
  - Thickness: 1.6mm
  - Grade: 1-2 W/mK Thermal Conductivity
  - Trace thickness: 2 oz
  - Insulation layer thickness: 215 um
  - Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

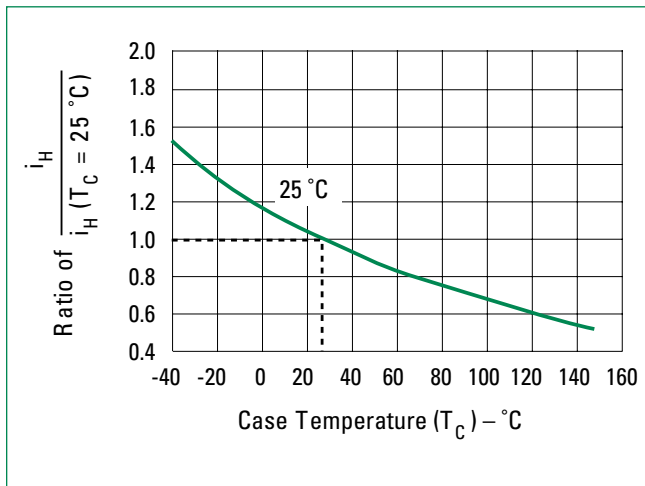
**V-I Characteristics**



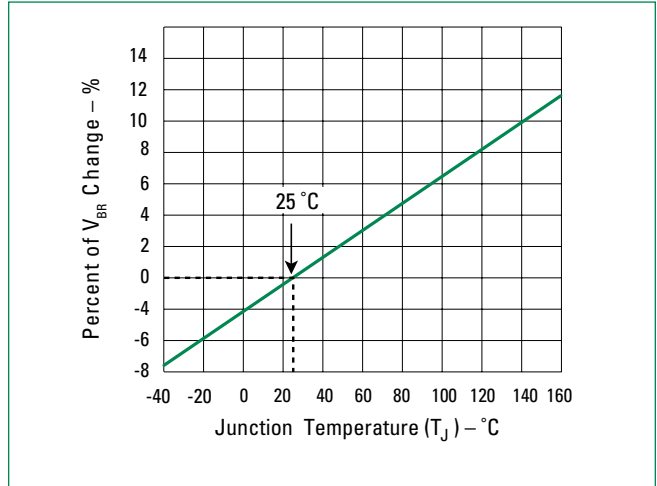
**$V_T$  vs.  $I_T$**



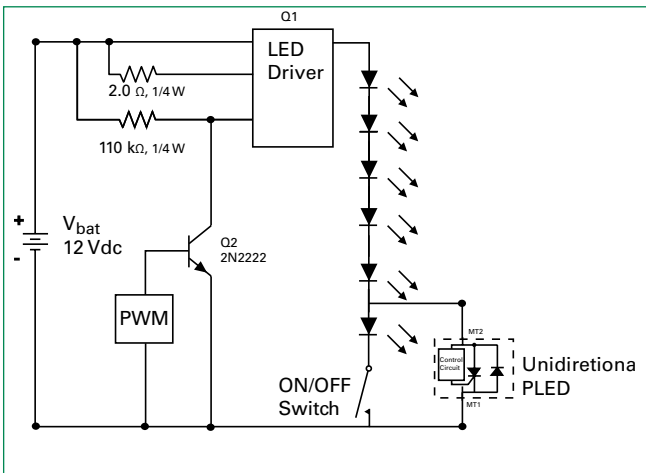
**Normalized DC Holding Current vs. Case Temperature**



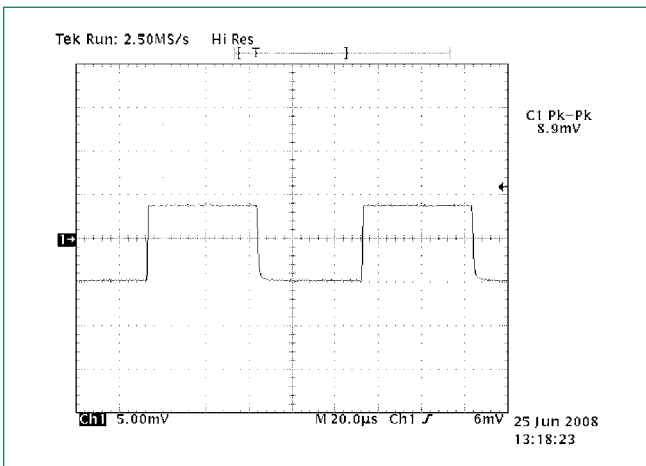
**$V_{BR}$  vs. Junction Temperature**



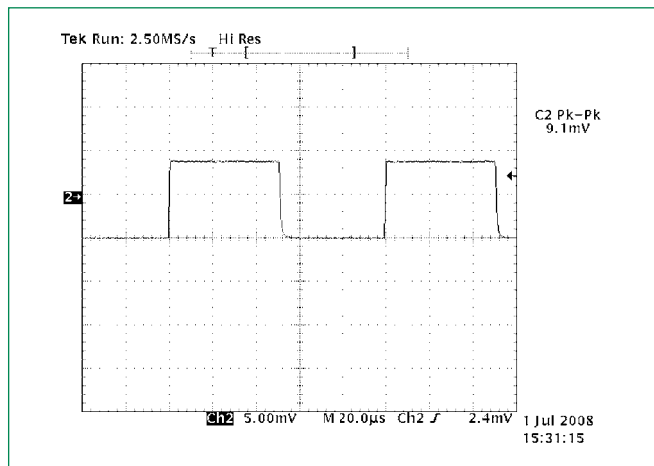
**LED Interference Test Circuit**



**6 LEDs in Series 50% Duty Cycle 10kHz**

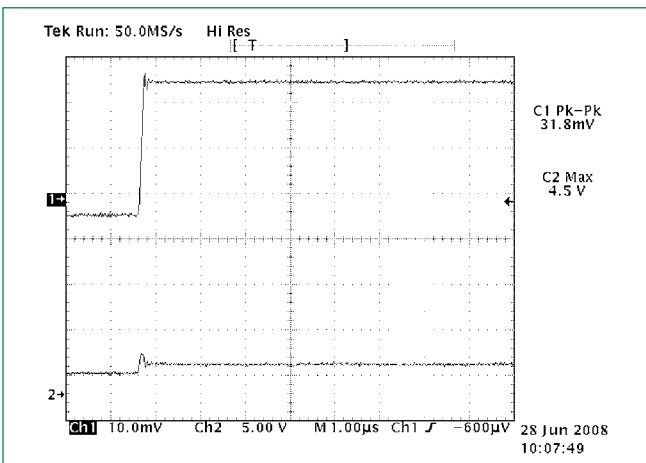


**5 LEDs and 1 PLED in Series 50% Duty Cycle 10kHz**



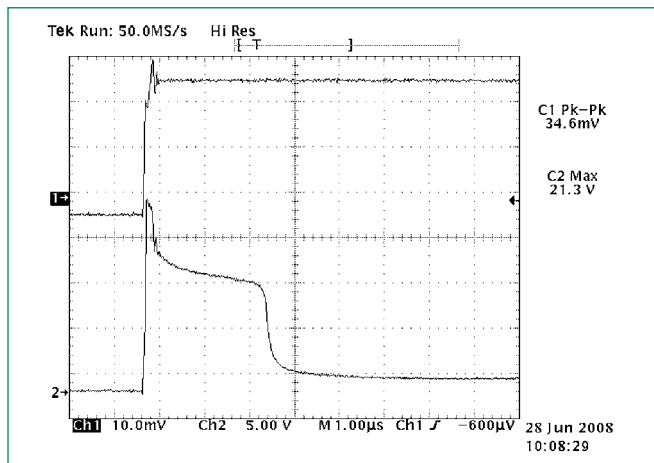
Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA\*8.9 = 89mA, while the second figure is 91mA.)

**PLED in the Off-State 10kHz**



Channel 1: current through LEDs (318 mA)  
Channel 2: voltage across PLED device (4.5 V)

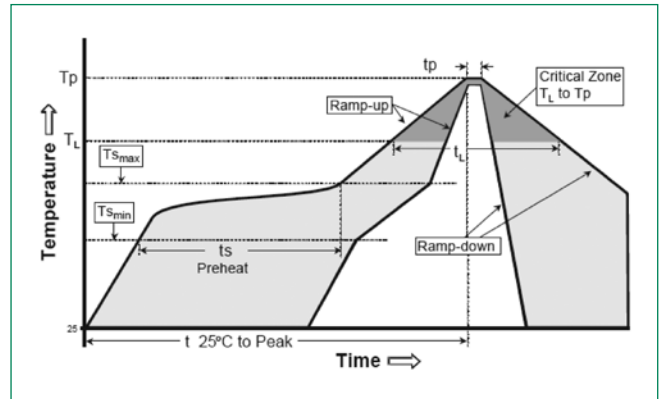
**PLED device zeners and then turns fully on 10kHz**



Channel 1: current through LEDs (346 mA) and PLED device once it is fully turned on 2.5 µsec later  
Channel 2: voltage across PLED device (21.3 V before PLED crowbars with 2 V drop)

**Soldering Parameters**

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Temperature ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes max
Do not exceed		260°C



**Physical Specifications**

<b>Terminal Material</b>	Copper Alloy
<b>Terminal Finish</b>	100% Matte Tin Plated
<b>Body Material</b>	UL recognized compound meeting flammability classification V-0

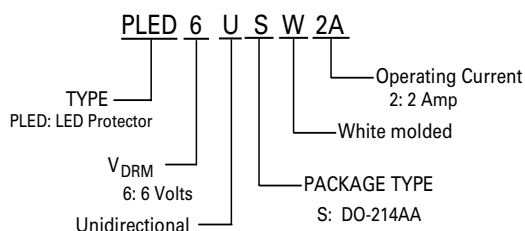
**Environmental Specifications**

<b>High Temperature Voltage Blocking</b>	MIL-STD-750: Method 1040, Condition A 80% min $V_{DRM}$ (VAC-peak), 150°C, 504 hours
<b>Temperature Cycling</b>	MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles
<b>Biased Temperature &amp; Humidity</b>	EIA/JEDEC: JESD22-A101 80% $V_{DRM}$ , 85°C, 85% RH, 1008 hours
<b>High Temperature Storage</b>	MIL-STD-750: Method 1031 150°C, 1008 hours
<b>Low Temperature Storage</b>	-65°C, 1008 hours
<b>Thermal Shock</b>	MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles
<b>Resistance to Solder Heat</b>	MIL-STD-750: Method 2031 260°C, 10 seconds

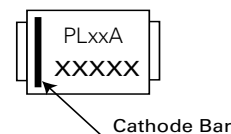
**Packaging**

Package	Description	Packaging Quantity	Industry Standard
S	DO-214AA	2500	EIA-481-1

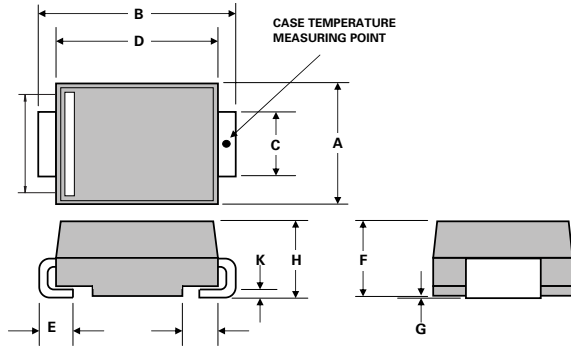
**Part Numbering System**



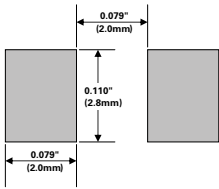
**Part Marking System**



**Dimensions - DO-214 AA Package**



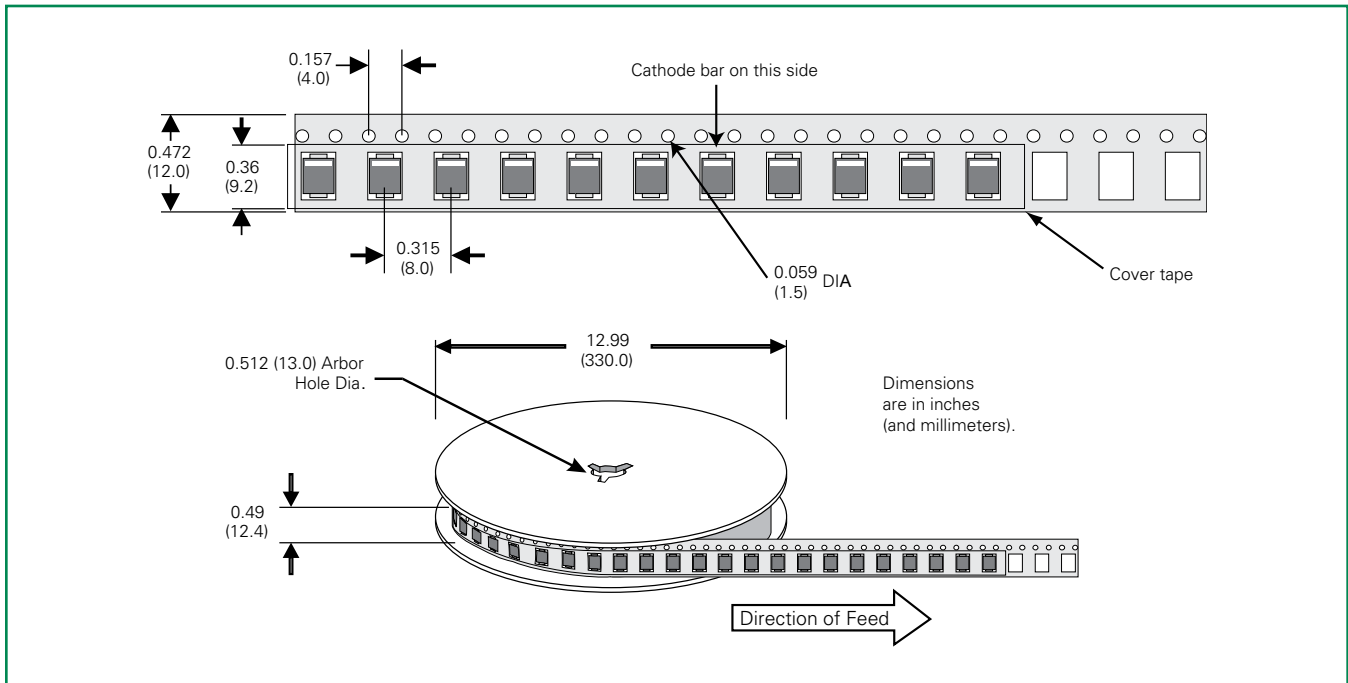
Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.130	0.156	3.30	3.95
B	0.201	0.220	5.10	5.60
C	0.077	0.087	1.95	2.20
D	0.159	0.181	4.05	4.60
E	0.030	0.063	0.75	1.60
F	0.075	0.096	1.90	2.45
G	0.002	0.008	0.05	0.20
H	0.077	0.104	1.95	2.65
K	0.006	0.016	0.15	0.41



Recommended solder pad layout  
(Reference Only)

**DO-214AA Embossed Carrier Reel Pack (RP)**

Meets all EIA-481-1 Standards



**Disclaimer Notice** - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at <http://www.littelfuse.com/disclaimer-electronics>.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)